



CYPRESS

CY7C3383A
CY7C3384AUltraLogic™ 3.3V High Speed
2K Gate CMOS FPGA

Features

- Very high speed
 - Loadable counter frequencies greater than 80 MHz
 - Chip-to-chip operating frequencies up to 60 MHz
- Unparalleled FPGA performance for counters, data path, state machines, arithmetic, and random logic
- High usable density
 - 12 x 16 array of 192 logic cells provides 6,000 total available gates
 - 2,000 typically usable "gate array" gates in 68- and 84-pin PLCC, and 100-pin TQFP packages
- Low power, high output drive
 - Standby current typically 250 μ A
 - 16-bit counter operating at 80 MHz consumes 20 mA
- Flexible logic cell architecture
 - Wide fan-in (up to 14 input gates)
 - Multiple outputs in each cell
 - Very low cell propagation delay (1.7 ns typical)
- Powerful design tools—*Warp3*™
 - Designs entered in VHDL, schematics, or both
 - Fast, fully automatic place and route
 - Waveform simulation with back annotated net delays
 - PC and workstation platforms
- Extensive 3rd party tool support

- See Development Systems section
- 5V tolerant Inputs (see I_{IH} spec)
- Robust routing resources
 - Fully-automatic place and route of designs using up to 100 percent of logic resources
 - No hand routing required
- 56 (CY7C3383A) to 80 (CY7C3384A) bidirectional input/output pins
- 6 dedicated input/high-drive pins
- 2 clock/dedicated input pins with fan-out-independent, low-skew nets
 - Clock skew <0.5 ns
- Input hysteresis provides high noise immunity
- Thorough testability at 3.3V
 - Built-in scan path permits 100 percent factory testing of logic and I/O cells
- 0.65 μ CMOS process with ViaLink™ programming technology
 - High-speed metal-to-metal link
 - Non-volatile antifuse technology
- 68-pin PLCC is pinout compatible with 1K (CY7C3382A) devices
- 84-pin PLCC is pinout compatible with 4K (CY7C3385A) devices
- 100-pin TQFP is pinout compatible with 1K (CY7C3382A) and 4K (CY7C3385A) devices
- Pinout compatible with 5V, 2K (CY7C383A/4A) devices

Functional Description

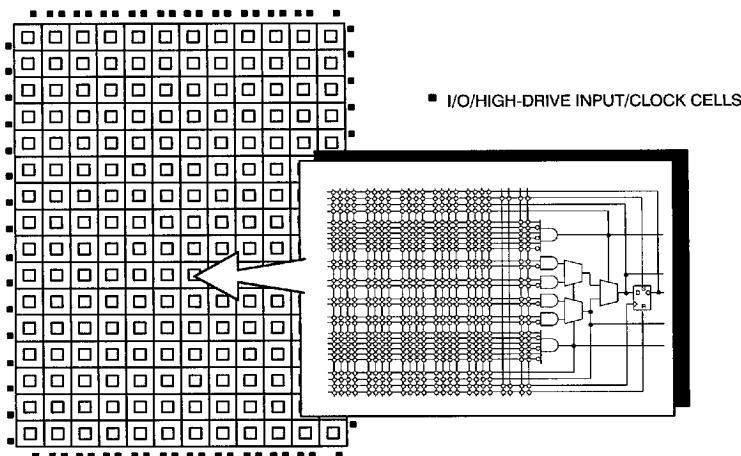
The CY7C3383A and CY7C3384A are 3.3V high speed CMOS user-programmable ASIC (pASIC™) devices. The 192 logic cell field-programmable gate array (FPGA) offers 2,000 typically usable "gate array" gates. This is equivalent to 6,000 EPLD or LCA gates. The CY7C3383A is available in a 68-pin PLCC packages. The CY7C3384A is available in an 84-pin PLCC and 100-pin TQFP packages.

Low-impedance, metal-to-metal ViaLink interconnect technology provides non-volatile custom logic capable of operating at speeds above 100 MHz. This permits high-density programmable devices to be used with today's fastest CISC and RISC microprocessors.

Designs are entered into the CY7C3383A and CY7C3384A using Cypress *Warp3* software or one of several third-party tools. See the Development Systems section of the *Programmable Logic Data Book* for more tools information. *Warp3* is a sophisticated CAE package that features schematic entry, waveform-based timing simulation, and VHDL design synthesis. The CY7C3383A and CY7C3384A feature ample on-chip routing channels for fast, fully automatic place and route of high gate utilization designs.

For detailed information about the pASIC380 architecture, see the pASIC380 Family datasheet.

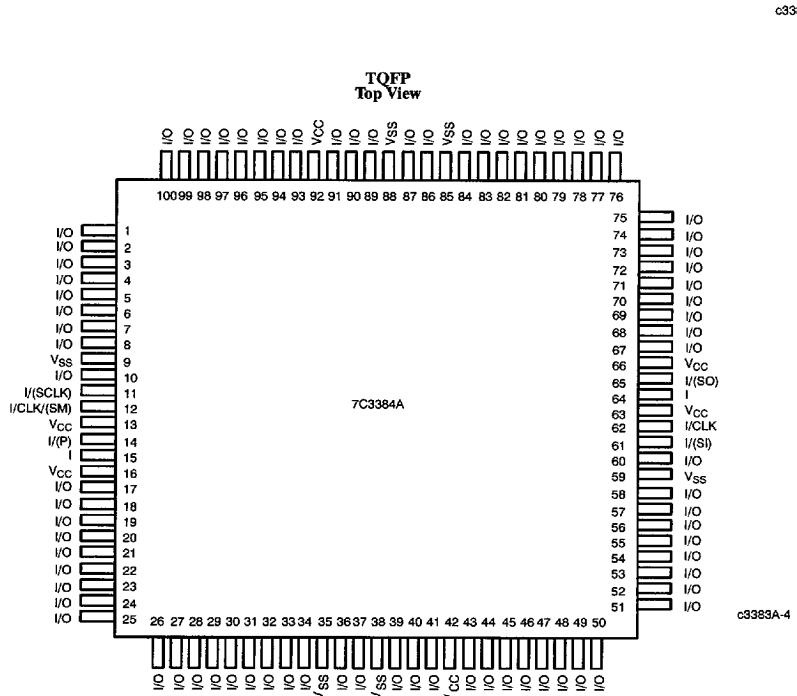
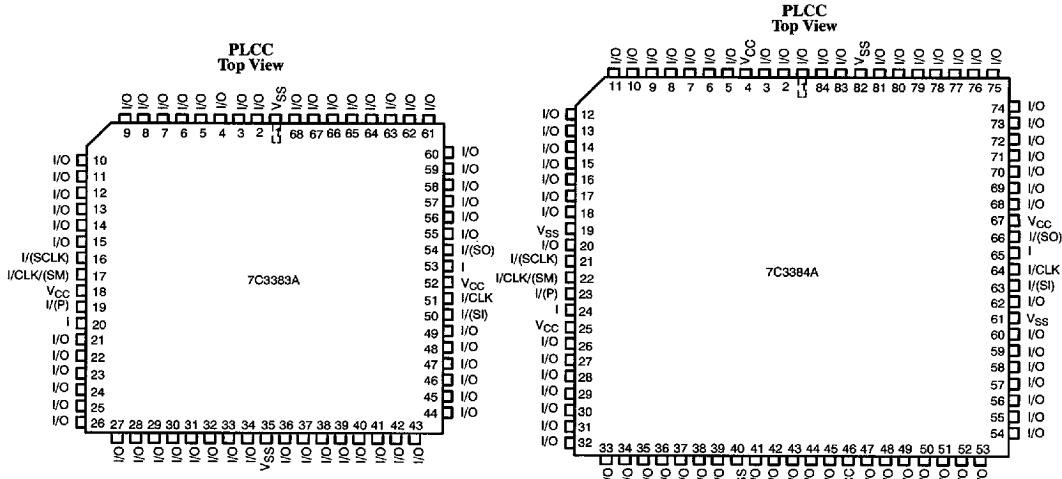
Logic Block Diagram



68, 84, or 100 PINS, INCLUDING 68 I/O CELLS, 6 INPUT HIGH-DRIVE CELLS, 2 INPUT/CLK (HIGH-DRIVE) CELLS

c3383A-1

Pin Configurations





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CY7C3383A
CY7C3384A**Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature

Ceramic -65°C to $+150^{\circ}\text{C}$
Plastic -40°C to $+125^{\circ}\text{C}$ Lead Temperature 300°C Supply Voltage -0.5V to 7.0V Input Voltage -0.5V to V_{CC} $+0.7\text{V}$ ESD Pad Protection $\pm 2000 \text{ V}$ DC Input Voltage -0.5V to 7.0V DC Input Current $\pm 20 \text{ mA}$
Latch-Up Current $\pm 200 \text{ mA}$ **Operating Range**

Range	Ambient Temperature	V_{CC}
Commercial	0°C to $+70^{\circ}\text{C}$	$3.3 \pm 0.3\text{V}$
Industrial	-40°C to $+85^{\circ}\text{C}$	$3.3 \pm 0.3\text{V}$

Delay Factor (K)

Speed Grade	Commercial		Industrial	
	Min.	Max.	Min.	Max.
-X	0.46	3.52	0.40	3.77
-0	0.46	2.61	0.40	2.81
-1	0.46	2.23	0.40	2.39

Electrical Characteristics Over the Operating Range

Parameter	Description	Test Conditions	Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	$\text{I}_{\text{OH}} = -2.4 \text{ mA}$	2.4		V
		$\text{I}_{\text{OH}} = -10.0 \mu\text{A}$	$\text{V}_{\text{CC}} - 0.1$		V
V_{OL}	Output LOW Voltage	$\text{I}_{\text{OL}} = 4 \text{ mA}$		0.4	V
		$\text{I}_{\text{OL}} = 10.0 \mu\text{A}$		0.1	V
V_{IH}	Input HIGH Voltage		2.0		V
V_{IL}	Input LOW Voltage			0.8	V
I_{IH}	Input HIGH Current Sink (for 5V Inputs)	$5\text{V} > \text{V}_{\text{IN}} > \text{V}_{\text{CC}}$		$12^{[1]}$	mA
I_{I}	Input Leakage Current	$\text{V}_{\text{IN}} = \text{V}_{\text{CC}}$ or V_{SS}	-10	+10	μA
I_{OZ}	Output Leakage Current—Three-State	$\text{V}_{\text{IN}} = \text{V}_{\text{CC}}$ or V_{SS}	-10	+10	μA
I_{OS}	Output Short Circuit Current ^[2]	$\text{V}_{\text{OUT}} = \text{V}_{\text{SS}}$	-5	-50	mA
		$\text{V}_{\text{OUT}} = \text{V}_{\text{CC}}$	15	100	mA
I_{CCI}	Standby Supply Current	$\text{V}_{\text{IN}}, \text{V}_{\text{I/O}} = \text{V}_{\text{CC}}$ or V_{SS}		650	μA

Capacitance

Parameter	Description	Test Conditions	Max.	Unit
C_{IN}	Input Capacitance ^[3]	$\text{T}_{\text{A}} = 25^{\circ}\text{C}, f = 1 \text{ MHz},$ $\text{V}_{\text{CC}} = 3.3\text{V}$	10	pF
C_{OUT}	Output Capacitance		10	pF

Note:

1. User must limit input current to 12 mA.
2. Only one output at a time. Duration should not exceed 30 seconds.
3. $\text{C}_{\text{IN}} = 40 \text{ pF}$ max. on $\text{I}_{\text{(SI)}}$ and $\text{I}_{\text{(P)}}$. Capacitance is sample tested.

Switching Characteristics (V_{CC}=3.3 V, T_A=25°C, K=1.00)

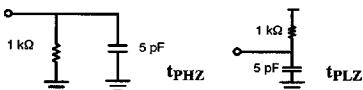
Parameter	Description	Propagation Delays ^[4] with Fanout of						Unit
		1	2	3	4	8		
LOGIC CELLS								
t _{PD}	Combinatorial Delay ^[5]	1.7	2.2	2.6	3.2	5.2	ns	
t _{SU}	Set-Up Time ^[5]	2.1	2.1	2.1	2.1	2.1	ns	
t _H	Hold Time	0.0	0.0	0.0	0.0	0.0	ns	
t _{CLK}	Clock to Q Delay	1.0	1.5	1.9	2.5	4.6	ns	
t _{CWHI}	Clock HIGH Time	2.0	2.0	2.0	2.0	2.0	ns	
t _{CWLO}	Clock LOW Time	2.0	2.0	2.0	2.0	2.0	ns	
t _{SET}	Set Delay	1.7	2.1	2.6	3.2	5.2	ns	
t _{RESET}	Reset Delay	1.5	1.9	2.2	2.7	4.3	ns	
t _{SW}	Set Width	1.9	1.9	1.9	1.9	1.9	ns	
t _{RW}	Reset Width	1.8	1.8	1.8	1.8	1.8	ns	

Parameter	Description	Propagation Delays ^[4]						Unit
		1	2	3	4	6	8	
INPUT CELLS								
t _{IN}	Input Delay (HIGH Drive)	2.4	2.5	2.6	2.7	3.0	3.3	ns
t _{INI}	Input, Inverting Delay (HIGH Drive)	2.5	2.6	2.7	2.8	3.1	3.4	ns
t _{IO}	Input Delay (Bidirectional Pad)	1.4	1.9	2.2	2.8	3.7	4.6	ns
t _{GCK}	Clock Buffer Delay ^[6]	2.7	2.8	2.8	2.9	2.9	3.0	ns
t _{GCKHI}	Clock Buffer Min. HIGH ^[6]	2.0	2.0	2.0	2.0	2.0	2.0	ns
t _{GCKLO}	Clock Buffer Min. LOW ^[6]	2.0	2.0	2.0	2.0	2.0	2.0	ns

Parameter	Description	Propagation Delays ^[4] with Output Load Capacitance (pF) of					Unit
		30	50	75	100	150	
OUTPUT CELLS							
t _{OUTLH}	Output Delay LOW to HIGH	2.7	3.4	4.2	5.0	6.7	ns
t _{OUTHL}	Output Delay HIGH to LOW	2.8	3.7	4.7	5.6	7.6	ns
t _{PZH}	Output Delay Three-State to HIGH	4.0	4.9	6.1	7.3	9.7	ns
t _{PZL}	Output Delay Three-State to LOW	3.6	4.2	5.0	5.8	7.3	ns
t _{PHZ}	Output Delay HIGH to Three-State ^[7]	2.9					ns
t _{PLZ}	Output Delay LOW to Three-State ^[7]	3.3					ns

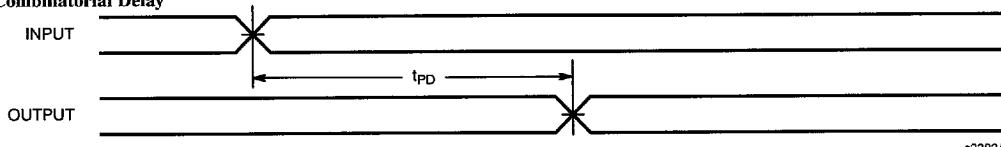
Notes:

- 4. Worst-case propagation delay times over process variation at V_{CC} = 3.3V and T_A = 25°C. Multiply by the appropriate delay factor, K, for speed grade to get worst-case parameters over full V_{CC} and temperature range as specified in the operating range. All inputs are TTL with 3-ns linear transition time between 0 and 3 volts.
- 5. These limits are derived from worst-case values for a representative selection of the slowest paths through the pASIC380 logic cell including net delays. Guaranteed delay values for specific paths should be determined from simulation results.
- 6. Clock buffer fanout refers to the maximum number of flip-flops per half column. The number of half columns used does not affect clock buffer delay.
- 7. The following loads are used for t_{PXZ}:



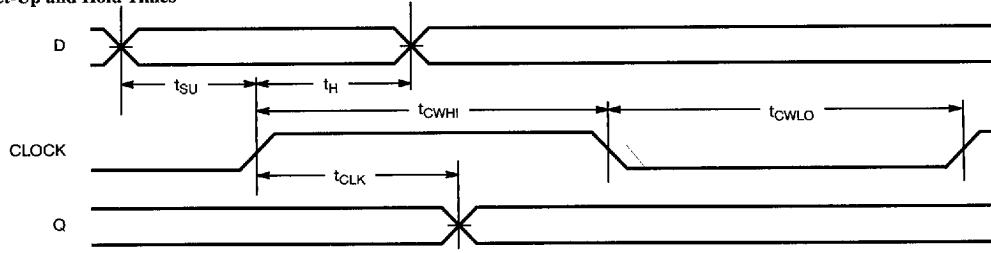
High Drive Buffer

Parameter	Description	# High Drives Wired Together	Propagation Delays ^[4] with Fanout of					Unit
			12	24	48	72	96	
t_{IN}	High Drive Input Delay	1	4.5	5.4				ns
		2		3.9	5.6			ns
		3			4.5	5.3	6.3	ns
		4				4.6	5.3	ns
t_{INI}	High Drive Input, Inverting Delay	1	4.7	5.6				ns
		2		4.0	5.8			ns
		3			4.6	5.5	6.4	ns
		4				4.8	5.5	ns

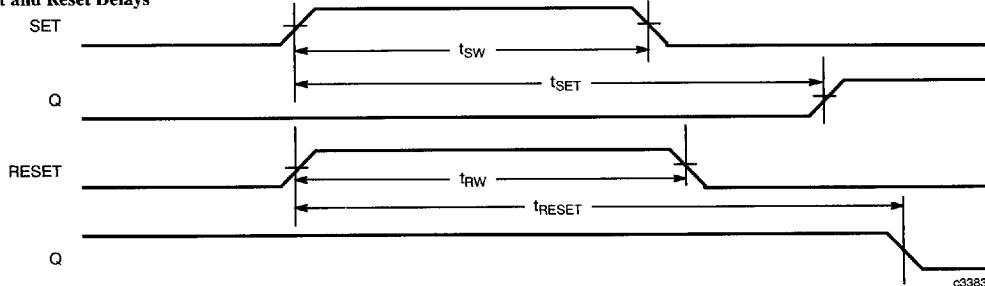
Switching Waveforms
Combinatorial Delay


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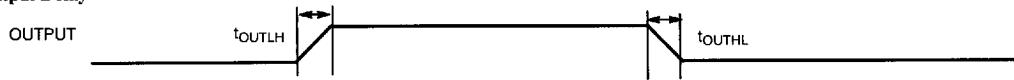
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Set-Up and Hold Times


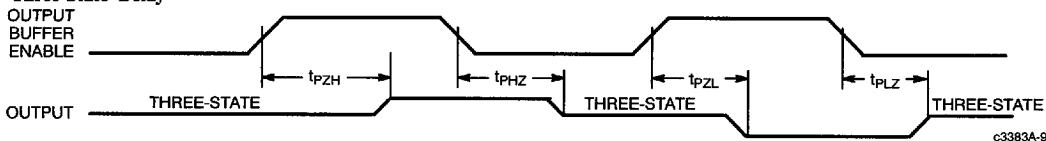
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Set and Reset Delays


c3383A-7

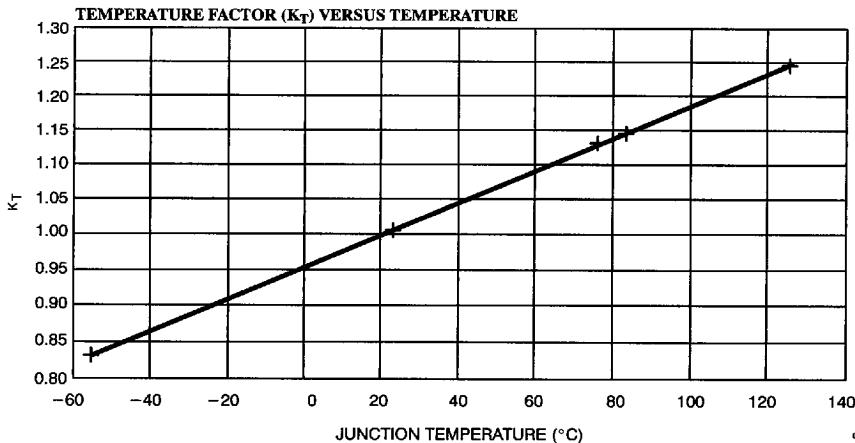
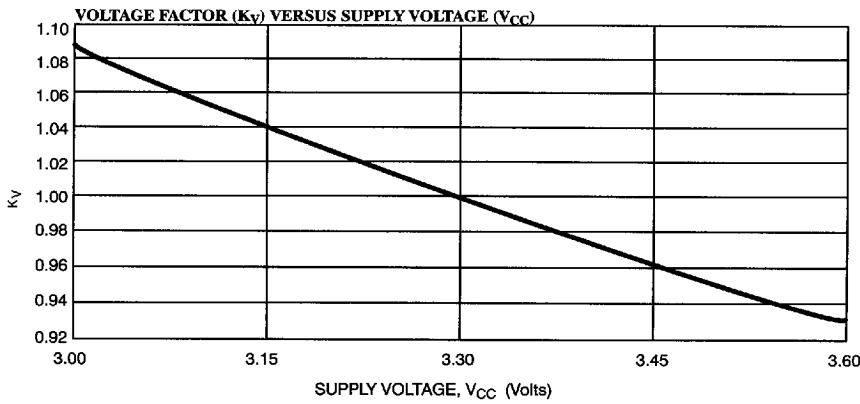
Output Delay


c3383A-8

Switching Waveforms (continued)
Three-State Delay

Typical AC Characteristics

Propagation delays depend on routing, fan-out, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst-case estimates are obtained when nominal propagation delays are multiplied by the appropriate

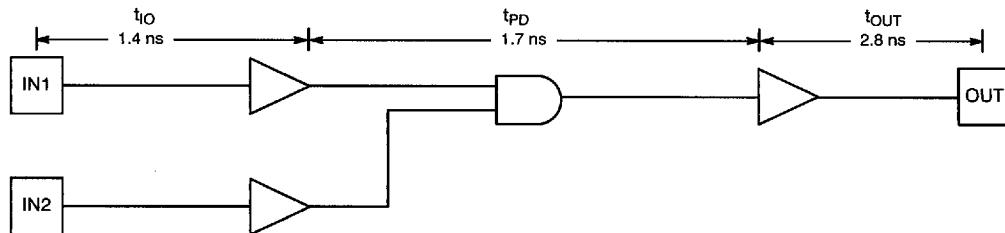
Delay Factor, K_v , as specified by the speed grade in the Delay Factor table. The effects of voltage and temperature variation are illustrated in the graphs below. The Warp3 Delay Modeler extracts specific timing parameters for precise simulation results following place and route.



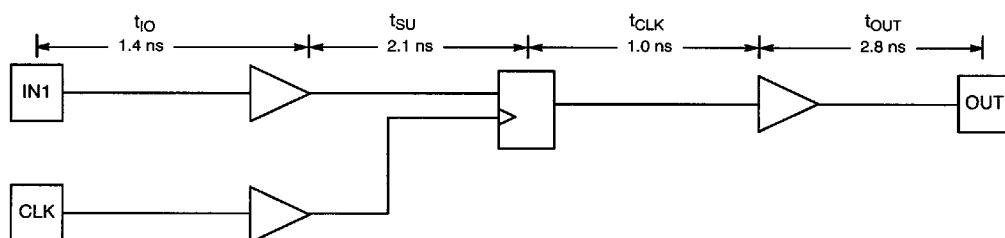
*THETA JA = 45 °C/WATT FOR PLCC



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CY7C3383A
CY7C3384A**Combinatorial Delay Example** (Load = 30 pF, K=1, Fanout=1)

c3383A-12

Sequential Delay Example (Load = 30 pF, K=1, Fanout=1)

c3383A-13

Ordering Information

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
1	CY7C3383A-1JC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C3383A-1JI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial
0	CY7C3383A-0JC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C3383A-0JI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial
X	CY7C3383A-XJC	J81	68-Lead Plastic Leaded Chip Carrier	Commercial
	CY7C3383A-XJI	J81	68-Lead Plastic Leaded Chip Carrier	Industrial

Speed Grade	Ordering Code	Package Name	Package Type	Operating Range
1	CY7C3384A-1AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C3384A-1JC	J83	84-Lead Plastic Leaded Chip Carrier	
	CY7C3384A-1AI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C3384A-1JI	J83	84-Lead Plastic Leaded Chip Carrier	
0	CY7C3384A-0AC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C3384A-0JC	J83	84-Lead Plastic Leaded Chip Carrier	
	CY7C3384A-0AI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C3384A-0JI	J83	84-Lead Plastic Leaded Chip Carrier	
X	CY7C3384A-XAC	A100	100-Pin Thin Quad Flat Pack	Commercial
	CY7C3384A-XJC	J83	84-Lead Plastic Leaded Chip Carrier	
	CY7C3384A-XAI	A100	100-Pin Thin Quad Flat Pack	Industrial
	CY7C3384A-XJI	J83	84-Lead Plastic Leaded Chip Carrier	

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